Intelligent Machine Learning Unit with NVIDIA Jetson AGX Xavier



## **IPC/COMPACT A3 - RML**

This fanless RML COMPACT-A3 generation is based on the Jetson AGX Xavier processor module and offers a wide range of interface options.

The robust and uncompromising industrial design allows the implementation in the most demanding AI railway and rolling stock applications and guarantees long term availability.

- 24/7 continuous operation
- Railway approved EN50155
- Power over Ethernet (PoE+), 48VDC out
- Passively cooled, no moving parts
- Long term availability with fixed BOM



## **Product Highlights**

No moving parts / passively cooled Shock and vibration resistant Galvanically isolated railway power supply Each LAN interface has its own dedicated NIC Long term availability (fixed BOM) Maintenance free Inertial measurement unit (IMU) Goldcap instead of battery backup for RTC

## **Product Features**

512-Core NVIDIA Volta™ GPU with 64 Tensor Cores 8-Core ARM v8.2 64-bit NVIDIA Carmel CPU 32GB 256-Bit LPDDR4x RAM soldered on board Socket for CFast Ethernet, USB, Passive or Active CAN LTE, GNSS and WiFi options Aluminum & stainless steel housing

## **Industries / Applications**

Railway (rolling stock) Transportation



			,
Processor module / Performance	on Conco		
JVIDIA Jetson AGX Xavier (32GB)   512-Core NVIDIA Volta™ GPU with 64 Tens 3-Core ARM v8.2 64-bit NVIDIA Carmel CPU	or Cores	•	•
NVIDIA Jetson AGX Xavier <b>Industrial</b> (JAXi)   512-Core NVIDIA Volta™ GPU with 64 Tensor Cores 8-Core ARM v8.2 64-bit NVIDIA Carmel CPU		optional pn: IPC/RMLA3K21-A201E	optional
Al Performance		32 TOPs	32 TOPs
Memory / Storage		32 1013	32 1013
Data L3 Cache Size		4MB	4MB
256-Bit LPDDR4x RAM soldered on board		32GB	32GB
MMC 5.1 Flash Storage on board		32GB / (64GB on JAXi)	32GB / (64GB on JAXi
nicroSD Card socket		1	1
1.2 socket <sup>2</sup>		1	1
Fast socket with retention frame <sup>2</sup>		1	1
eatures			
nertial measurement unit (IMU) STMicroelectronics ISM330DHCXTR		•	•
Real time clock (RTC) with goldcap backup (charge holds typ. 48h)		•	•
lardware Watchdog & Temperature supervisor		•	•
ntelligent power management		•	•
Communication Interfaces			
Graphic interface		DisplayPort 1.2	DisplayPort 1.2
ISB version 3.1	(Type A )	2	2
nternal USB version 2.0 OTG behind the cover	(micro USB Type AB )	1	1
thernet 10/100/1000Mbit	(M12 female x-coded)	2	2
ower over Ethernet - IEEE802.3at 10/100/1000Mbit	(M12 female x-coded)	4	4
SE - Power sourcing equipment, producing 48VDC out	(DCLIDO)	(total max power: 39W)	(total max power: 39W)
ctive/passive-CAN ESD protected, isolated S232 / RS422/485	(DSUB9) (DSUB9)	2 antional	2 ontional
5232 / K3422/465 ligital I/O's, 24VDC	(up to 4 inputs & 4 outputs)	optional	optional
nalog input, 16bit resolution, voltage input: -10+10V / 0 30V Accuracy: +/-0.1%	(4 inputs)	optional optional	optional optional
nalog input, 16bit resolution, voltage input: -10+16v / 0 50v	(4 inputs)	optional	optional
2C bus <sup>2</sup>	(+ прису	1	1
luzzer		1	<u>·</u> 1
AIPI CSI-2 / GMSL 1&2 Camera interface <sup>1</sup>		on request	on request
Vireless Connectivity			
Cellular 4G Module (LTE/UMTS/GSM) with GNSS Sierra Wireless MC7455- M2M only!	(full size miniPCle Slot)	3x SMA	none
Oual SIM Support (nanoSIM to mPCle slot)		•	none
Vireless LAN IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO Sparklan WPEB 263ACNI(E	(half size MiniPCle Slot)	2x RP-SMA	none
ligh accuracy GNSS module 1 u-blox ZED-F9P module		optional	none
echnical Data			
oimensions w255 x h103 x d125 mm (housing, incl. mounting)		•	•
let weight in gram		~2800	~2800
olated input voltage with ignition controller and reverse polarity protection	(M12 5P male a-coded)	16.8 45VDC	16.8 45VDC
nterruption of voltage supply time		>10ms	>10ms
nvironmental Conditions			
perating temperature <sup>3</sup>		−25°C +55°C	−25°C +55°C
torage temperature		-25°C +80°C	−25°C +80°C
perating temperature (JAXi), complies with EN50155 class OT4 <sup>3</sup>		-40°C +70°C	-40°C +70°C
torage temperature (JAXi)		−25°C +85°C	−25°C +85°C
gress protection standard according to EN60529		IP20 PCX	IP20 PCX
onformal coating <sup>4</sup> hock		EN61373	EN61373
		EN61373	EN61373
			EN50121-3-2
		FI\I5()   /   - 5 - /	
MI-Conformity		EN50121-3-2 FN45545-2 HI 3	
MI-Conformity ire protection (designed to meet)		EN45545-2 HL3	EN45545-2 HL3
ATBF @ 25°C ambient according to Telcordia SR-332, environment GB			

Product specifications subject to change without notice. | All data is for information purposes only and not guaranteed for legal purposes. Information in this data sheet has been carefully checked and is believed to be accurate. However, no responsibility is assumed for inaccuracies. Please refer to the user documentation for additional product specification.

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<sup>3</sup> Depending on installation situation and interface connection. Please see user documentation.

Syslogic Datentechnik AG Täfernstrasse 28 CH-5405 Baden Dättwil

For further information and support: info@syslogic.com support@syslogic.com www.syslogic.com

+41 56 200 90 40 +49 7741 9671-420 Switzerland (Headquarters) Germany and Austria



<sup>4</sup>On all possible components (excl. NVIDIA Xavier Module, connectors and wireless devices)